

FM0206-L

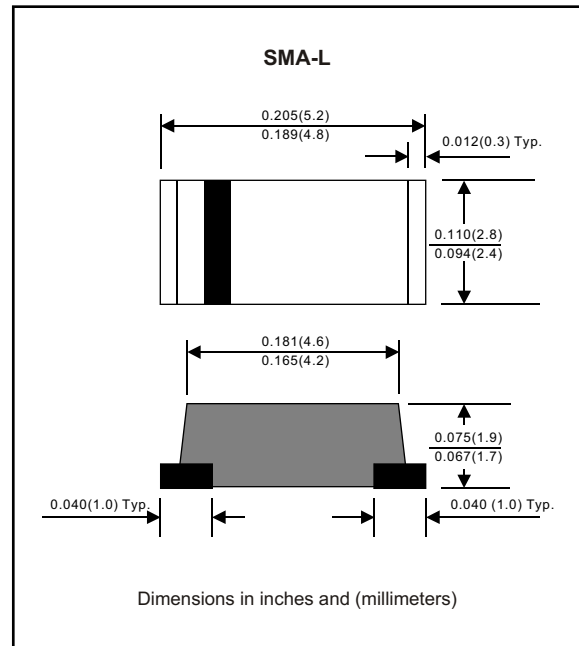
Silicon epitaxial planer type

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0 Utilizing Flame Retardant Epoxy Molding Compound.
- For surface mounted applications.
- Exceeds environmental standards of ML-S-19500 / 228
- Low leakage current

Mechanical data

Case : Moulded plastic, JEDEC DO-214AC
 Terminals : Solder plated, solderable per ML-STD-750, Method 2026
 Polarity : Indicated by cathode band
 Mounting Position : Any
 Weight : 0.0015 ounce, 0.05 gram



MAXIMUM RATINGS (AT T_A=25°C unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I _O			0.2	A
Forward surge current	8.3ms single half sine-wave superimposed on rate load (JEDEC methode)	I _{FSM}			15	A
Reverse current	V _R = V _{RRM} T _A = 25°C	I _R			5	uA
	V _R = V _{RRM} T _A = 125°C				20	uA
Thermal resistance	Junction to ambient	R _{JA}		88		°C / w
Diode junction capacitance	f=1MHz and applied 4vDC reverse voltage	C _J		120		pF
Storage temperature		T _{STG}	-55		+150	°C

SYMBOLS	MARKING CODE	V _{RRM} *1 (V)	V _{RMS} *2 (V)	V _R *3 (V)	V _F *4 (V)	Operating temperature (°C)
FM0206	SK14	6.0	4.2	6.0	0.50	-55 to +125

- *1 Repetitive peak reverse voltage
- *2 RMS voltage
- *3 Continuous reverse voltage
- *4 Maximum forward voltage

RATING AND CHARACTERISTIC CURVES (FM0206-L)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

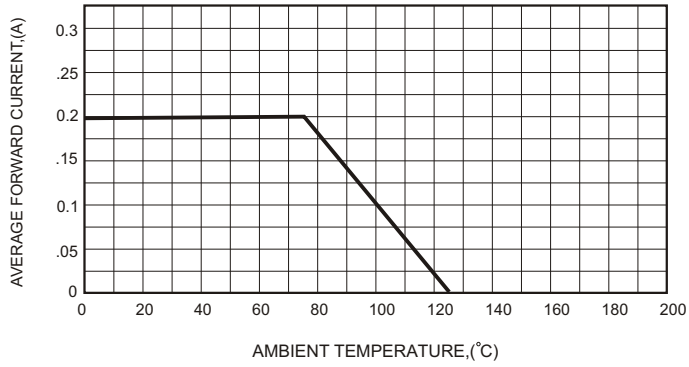


FIG.2-TYPICAL FORWARD CHARACTERISTICS

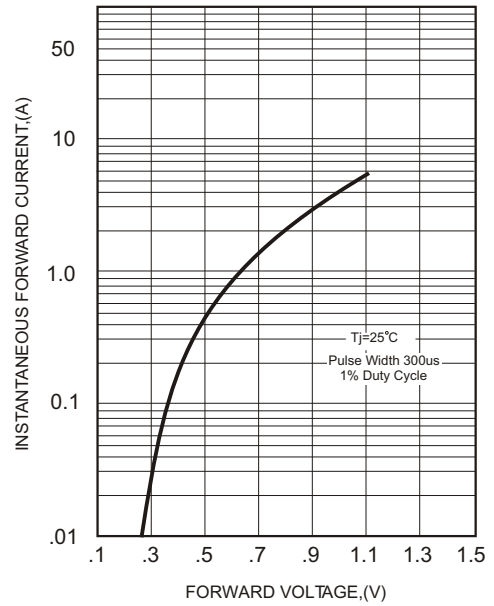


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

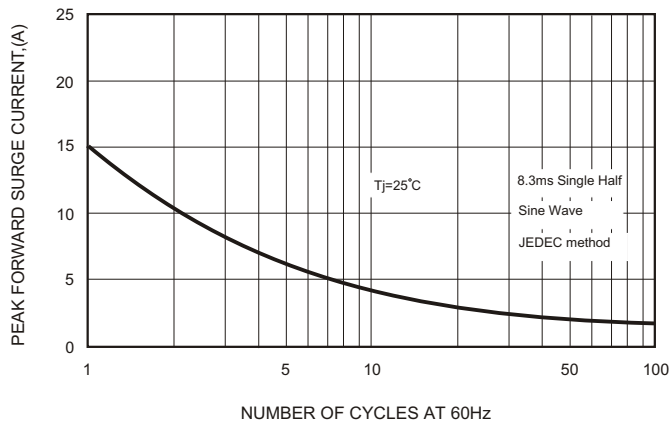


FIG.4-TYPICAL JUNCTION CAPACITANCE

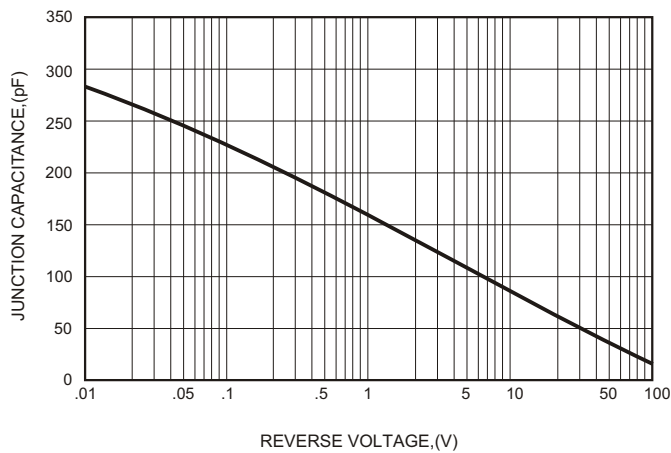


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

